



# BCX56T series

80 V, 1 A NPN power bipolar transistors

Rev. 1 — 22 August 2019

Product data sheet

## 1. Product profile

### 1.1. General description

NPN power transistors in a medium power SOT89 (SC-62) flat lead Surface-Mounted Device (SMD) plastic package.

Table 1. Product overview

Type number	Package		PNP complement
	Nexperia	JEDEC	
BCX56T	SOT89	SC-62	BCX53T
BCX56-10T			BCX53-10T
BCX56-16T			BCX53-16T

### 1.2. Features and benefits

- High collector current capability  $I_C$  and  $I_{CM}$
- Three current gain selections
- High power dissipation capability
- AEC-Q101 qualified

### 1.3. Applications

- Linear voltage regulators
- MOSFET drivers
- Low-side switches
- Power management
- Amplifiers

### 1.4. Quick reference data

Table 2. Quick reference data

$T_{amb} = 25^\circ\text{C}$  unless otherwise specified.

Symbol	Parameter	Conditions		Min	Typ	Max	Unit
$V_{CEO}$	collector-emitter voltage	open base		-	-	80	V
$I_C$	collector current			-	-	1	A
$I_{CM}$	peak collector current	single pulse; $t_p \leq 1\text{ ms}$		-	-	2	A

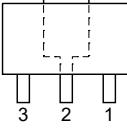
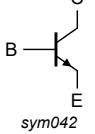
**nexperia**

Symbol	Parameter	Conditions		Min	Typ	Max	Unit
$h_{FE}$	DC current gain	$V_{CE} = 2 \text{ V}; I_C = 150 \text{ mA}$	[1]	63	-	250	
	BCX56T			63	-	160	
	BCX56-10T			100	-	250	
	BCX56-16T						

[1] pulsed;  $t_p \leq 300 \mu\text{s}$ ;  $\delta \leq 0.02$

## 2. Pinning information

Table 3. Pinning

Pin	Symbol	Description	Simplified outline	Graphic symbol
1	E	emitter		
2	C	collector		
3	B	base		

## 3. Ordering information

Table 4. Ordering information

Type number	Package		
	Name	Description	Version
BCX56T	SC-62	plastic, surface-mounted package; 3 leads; 1.5 mm pitch; 4.5 mm x 2.5 mm x 1.5 mm body	SOT89
BCX56-10T			
BCX56-16T			

## 4. Marking

Table 5. Marking

Type number	Marking code
BCX56T	A7
BCX56-10T	A5
BCX56-16T	A6

## 5. Limiting values

**Table 6. Limiting values**

In accordance with the Absolute Maximum Rating System (IEC 60134).

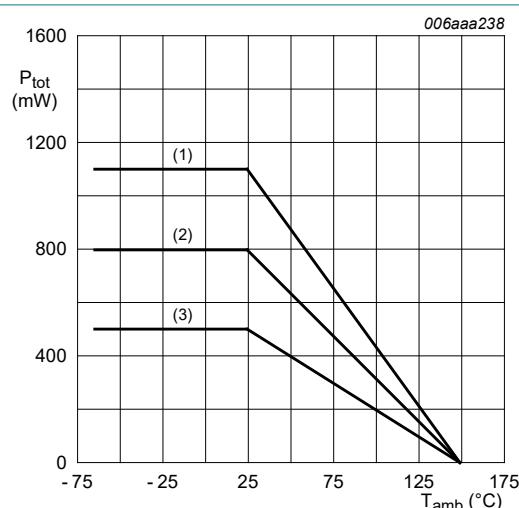
$T_{amb} = 25^\circ\text{C}$  unless otherwise specified.

Symbol	Parameter	Conditions	Min	Max	Unit
$V_{CBO}$	collector-base voltage	open emitter	-	100	V
$V_{CEO}$	collector-emitter voltage	open base	-	80	V
$V_{EBO}$	emitter-base voltage	open collector	-	5	V
$I_C$	collector current		-	1	A
$I_{CM}$	peak collector current	single pulse; $t_p \leq 1\text{ ms}$	-	2	A
$I_B$	base current		-	200	mA
$I_{BM}$	peak base current	single pulse; $t_p \leq 1\text{ ms}$	-	300	mA
$P_{tot}$	total power dissipation	$T_{amb} \leq 25^\circ\text{C}$	[1]	-	mW
			[2]	-	mW
			[3]	-	mW
$T_j$	junction temperature		-	150	°C
$T_{amb}$	ambient temperature		-55	150	°C
$T_{stg}$	storage temperature		-65	150	°C

[1] Device mounted on an FR4 PCB; single-sided copper; tin-plated and standard footprint.

[2] Device mounted on an FR4 PCB; single-sided copper; tin-plated; mounting pad for collector  $1\text{ cm}^2$ .

[3] Device mounted on an FR4 PCB; single-sided copper; tin-plated; mounting pad for collector  $6\text{ cm}^2$ .



(1) FR4 PCB; mounting pad for collector  $6\text{ cm}^2$

(2) FR4 PCB; mounting pad for collector  $1\text{ cm}^2$

(3) FR4 PCB; standard footprint

**Fig. 1. Power derating curves**

## 6. Thermal characteristics

**Table 7. Thermal characteristics**

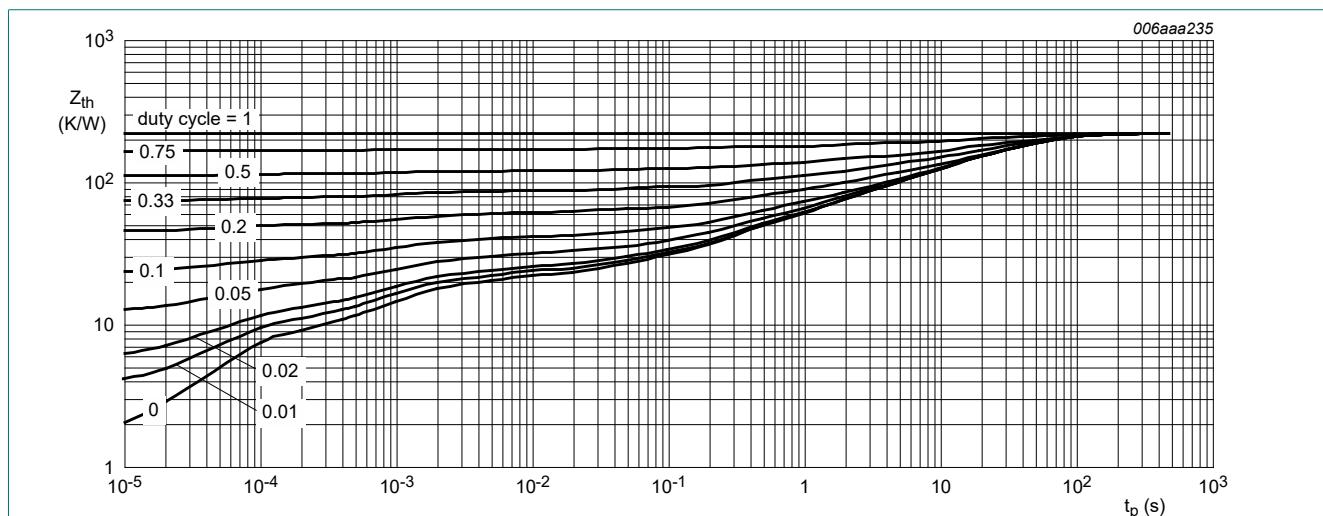
$T_{amb} = 25^\circ\text{C}$  unless otherwise specified.

Symbol	Parameter	Conditions		Min	Typ	Max	Unit
$R_{th(j-a)}$	thermal resistance from junction to ambient	in free air	[1]	-	-	250	K/W
			[2]	-	-	157	K/W
			[3]	-	-	114	K/W

[1] Device mounted on an FR4 PCB; single-sided copper; tin-plated and standard footprint.

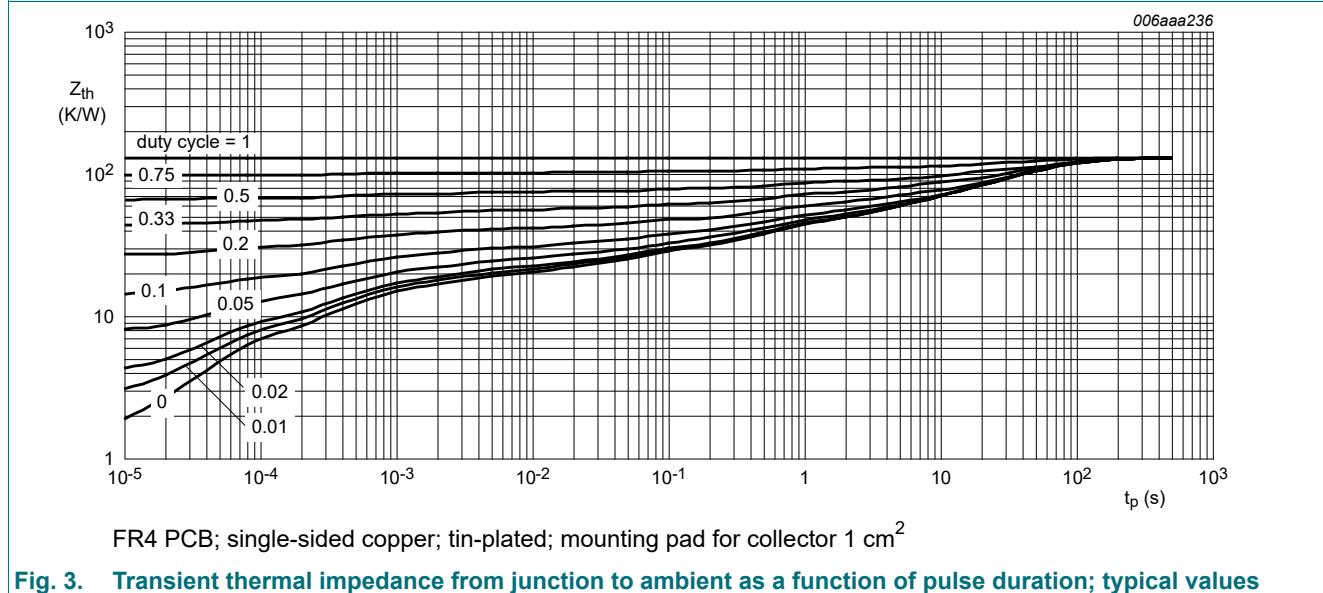
[2] Device mounted on an FR4 PCB; single-sided copper; tin-plated; mounting pad for collector  $1\text{ cm}^2$ .

[3] Device mounted on an FR4 PCB; single-sided copper; tin-plated; mounting pad for collector  $6\text{ cm}^2$ .



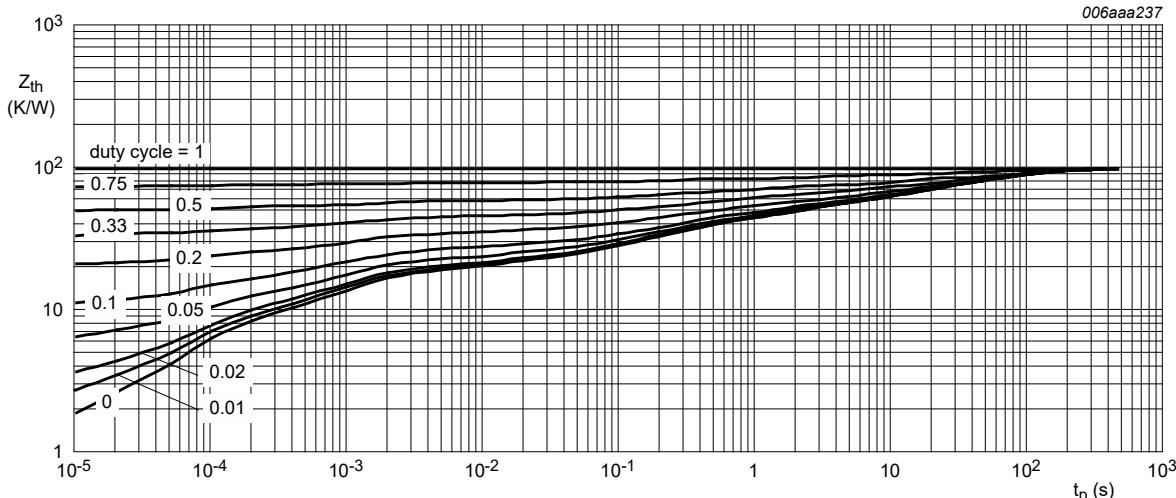
FR4 PCB; single-sided copper; tin-plated and standard footprint

**Fig. 2. Transient thermal impedance from junction to ambient as a function of pulse duration; typical values**



FR4 PCB; single-sided copper; tin-plated; mounting pad for collector  $1\text{ cm}^2$

**Fig. 3. Transient thermal impedance from junction to ambient as a function of pulse duration; typical values**



FR4 PCB; single-sided copper; tin-plated; mounting pad for collector 6 cm<sup>2</sup>

Fig. 4. Transient thermal impedance from junction to ambient as a function of pulse duration; typical values

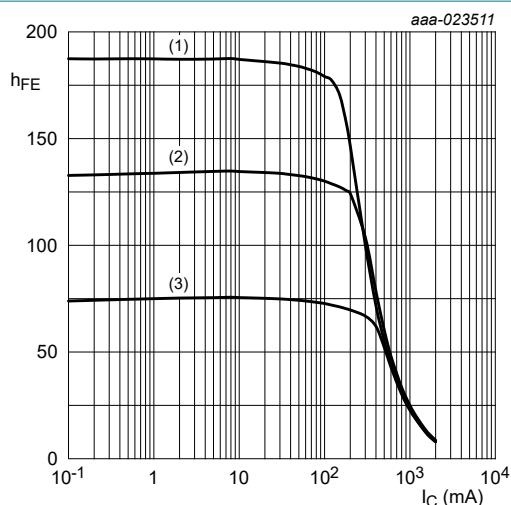
## 7. Characteristics

Table 8. Characteristics

$T_{amb} = 25^\circ\text{C}$  unless otherwise specified.

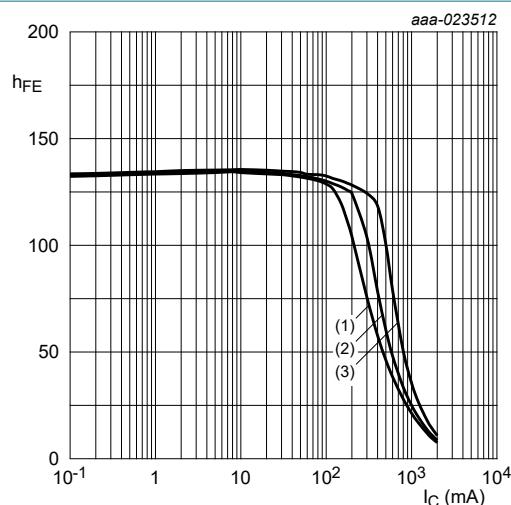
Symbol	Parameter	Conditions	Min	Typ	Max	Unit	
$V_{(BR)CBO}$	collector-base breakdown voltage	$I_C = 100 \mu\text{A}; I_E = 0 \text{ A}$	100	-	-	V	
$V_{(BR)CEO}$	collector-emitter breakdown voltage	$I_C = 2 \text{ mA}; I_E = 0 \text{ A}$	80	-	-	V	
$V_{(BR)EBO}$	emitter-base breakdown voltage	$I_E = 100 \mu\text{A}; I_C = 0 \text{ A}$	5	-	-	V	
$I_{CBO}$	collector-base cut-off current	$V_{CB} = 30 \text{ V}; I_E = 0 \text{ A}$	-	-	100	nA	
		$V_{CB} = 30 \text{ V}; I_E = 0 \text{ A}; T_j = 150^\circ\text{C}$	-	-	10	$\mu\text{A}$	
$I_{EBO}$	emitter-base cut-off current	$V_{EB} = 5 \text{ V}; I_C = 0 \text{ A}$	-	-	100	nA	
$h_{FE}$	DC current gain						
	BCX56T, -10T, -16T	$V_{CE} = 2 \text{ V}; I_C = 5 \text{ mA}$	63	-	-		
		$V_{CE} = 2 \text{ V}; I_C = 500 \text{ mA}$	[1]	40	-		
	BCX56T	$V_{CE} = 2 \text{ V}; I_C = 150 \text{ mA}$	[1]	63	-	250	
	BCX56-10T	$V_{CE} = 2 \text{ V}; I_C = 150 \text{ mA}$	[1]	63	-	160	
	BCX56-16T	$V_{CE} = 2 \text{ V}; I_C = 150 \text{ mA}$	[1]	100	-	250	
$V_{CEsat}$	collector-emitter saturation voltage	$I_C = 500 \text{ mA}; I_B = 50 \text{ mA}$	[1]	-	-	mV	
$V_{BE}$	base-emitter voltage	$V_{CE} = 2 \text{ V}; I_C = 500 \text{ mA}$	[1]	-	-	1	V
$f_T$	transition frequency	$V_{CE} = 5 \text{ V}; I_C = 50 \text{ mA}; f = 100 \text{ MHz}$	-	155	-	MHz	
$C_c$	collector capacitance	$V_{CB} = 10 \text{ V}; I_E = i_e = 0 \text{ A}; f = 1 \text{ MHz}$	-	4.5	-	pF	

[1] pulsed;  $t_p \leq 300 \mu\text{s}$ ;  $\delta \leq 0.02$



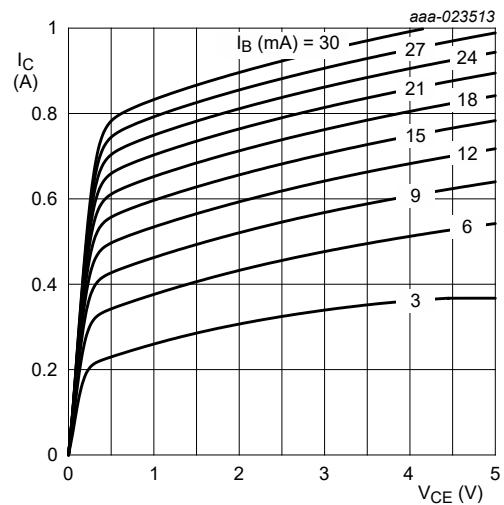
$V_{CE} = 2 \text{ V}$   
 (1)  $T_{amb} = 100 \text{ }^{\circ}\text{C}$   
 (2)  $T_{amb} = 25 \text{ }^{\circ}\text{C}$   
 (3)  $T_{amb} = -55 \text{ }^{\circ}\text{C}$

**Fig. 5. DC current gain as a function of collector current; typical values**



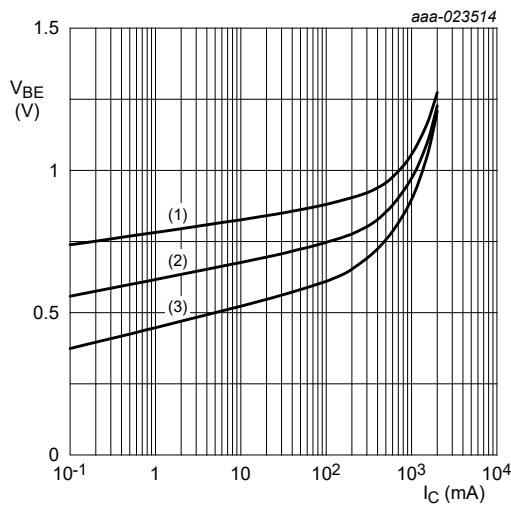
$T_{amb} = 25 \text{ }^{\circ}\text{C}$   
 (1)  $V_{CE} = 1 \text{ V}$   
 (2)  $V_{CE} = 2 \text{ V}$   
 (3)  $V_{CE} = 5 \text{ V}$

**Fig. 6. DC current gain as a function of collector current; typical values**



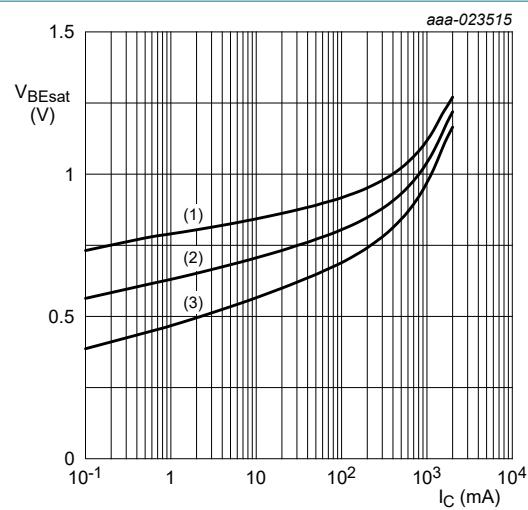
$T_{amb} = 25 \text{ }^{\circ}\text{C}$

**Fig. 7. Collector current as a function of collector-emitter voltage; typical values**



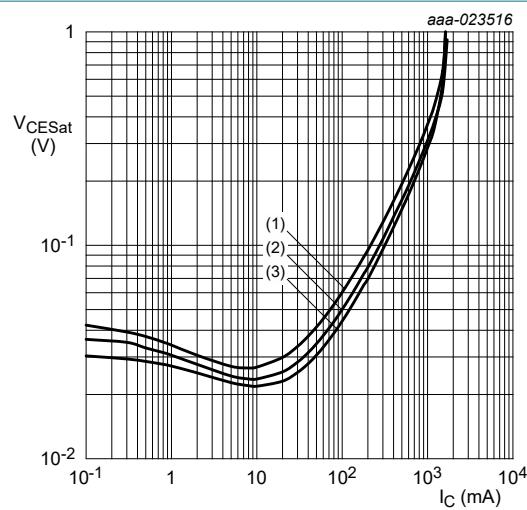
$V_{CE} = 2 \text{ V}$   
 (1)  $T_{amb} = -55 \text{ }^{\circ}\text{C}$   
 (2)  $T_{amb} = 25 \text{ }^{\circ}\text{C}$   
 (3)  $T_{amb} = 100 \text{ }^{\circ}\text{C}$

**Fig. 8. Base-emitter voltage as a function of collector current; typical values**



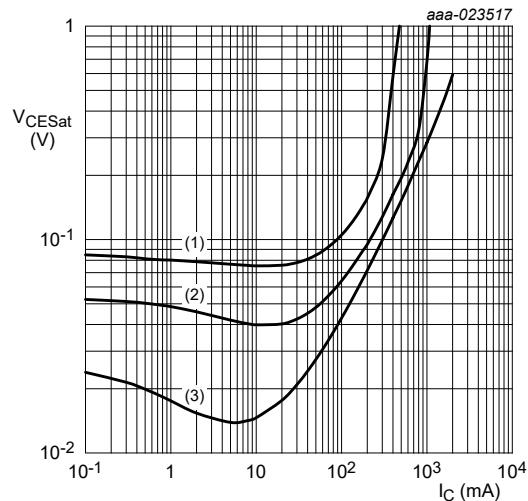
$I_C/I_B = 10$   
 (1)  $T_{amb} = -55 \text{ }^{\circ}\text{C}$   
 (2)  $T_{amb} = 25 \text{ }^{\circ}\text{C}$   
 (3)  $T_{amb} = 100 \text{ }^{\circ}\text{C}$

**Fig. 9. Base-emitter saturation voltage as a function of collector current; typical values**



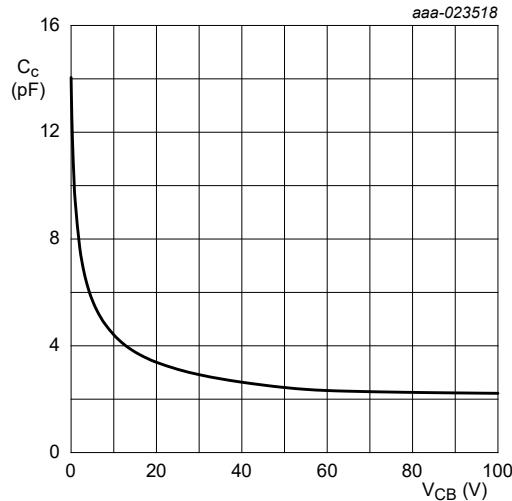
$I_C/I_B = 10$   
 (1)  $T_{amb} = 100 \text{ }^{\circ}\text{C}$   
 (2)  $T_{amb} = 25 \text{ }^{\circ}\text{C}$   
 (3)  $T_{amb} = -55 \text{ }^{\circ}\text{C}$

**Fig. 10. Collector-emitter saturation voltage as a function of collector current; typical values**



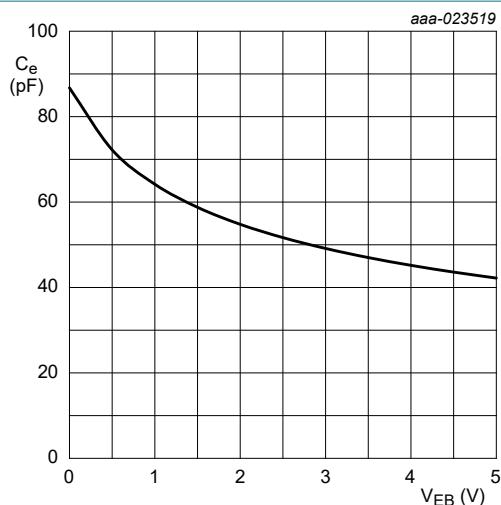
$T_{amb} = 25 \text{ }^{\circ}\text{C}$   
 (1)  $I_C/I_B = 50$   
 (2)  $I_C/I_B = 20$   
 (3)  $I_C/I_B = 5$

**Fig. 11. Collector-emitter saturation voltage as a function of collector current; typical values**



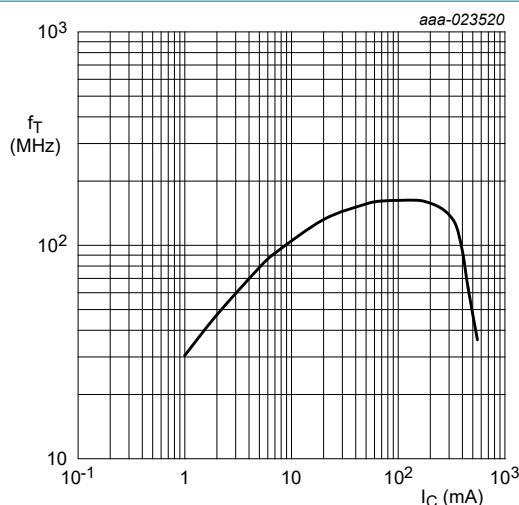
$f = 1 \text{ MHz}; T_{amb} = 25 \text{ }^{\circ}\text{C}$

**Fig. 12. Collector capacitance as a function of collector-base voltage; typical values**



$f = 1 \text{ MHz}$ ;  $T_{\text{amb}} = 25 \text{ }^{\circ}\text{C}$

**Fig. 13. Emitter capacitance as a function of emitter-base voltage; typical values**



$V_{\text{CE}} = 5 \text{ V}$   
 $f = 100 \text{ MHz}$ ;  $T_{\text{amb}} = 25 \text{ }^{\circ}\text{C}$

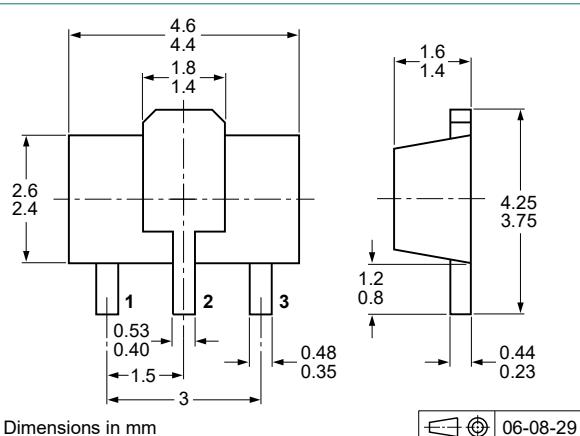
**Fig. 14. Transition frequency as a function of collector current; typical values**

## 8. Test information

### 8.1. Quality information

This product has been qualified in accordance with the Automotive Electronics Council (AEC) standard Q101 - Stress test qualification for discrete semiconductors, and is suitable for use in automotive applications.

## 9. Package outline



**Fig. 15. Package outline SOT89 (SC-62)**

## 10. Soldering

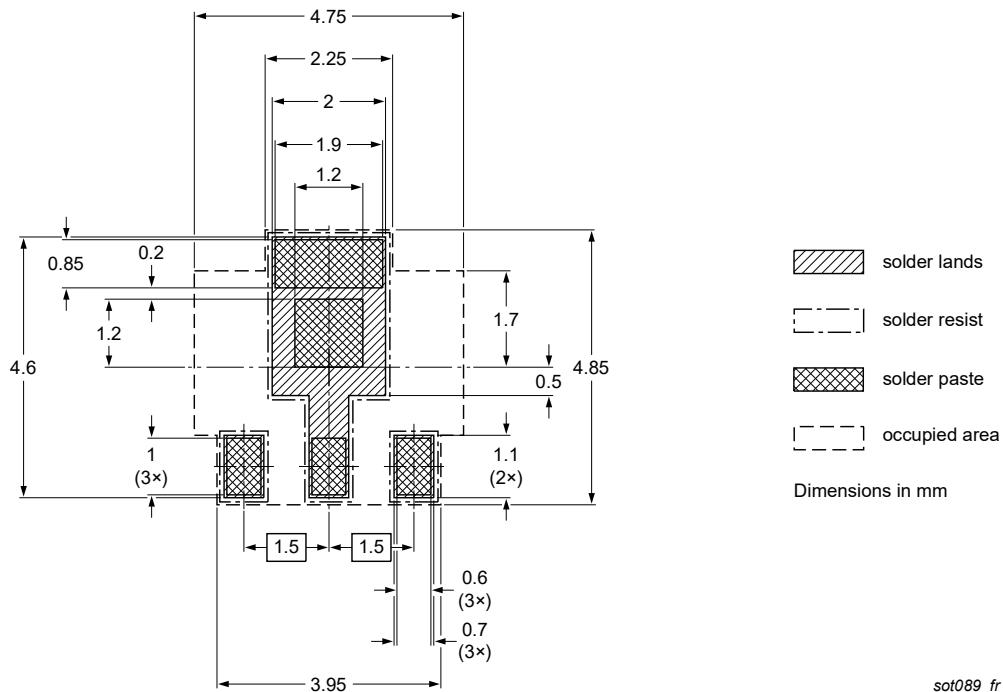


Fig. 16. Reflow soldering footprint for SOT89 (SC62)

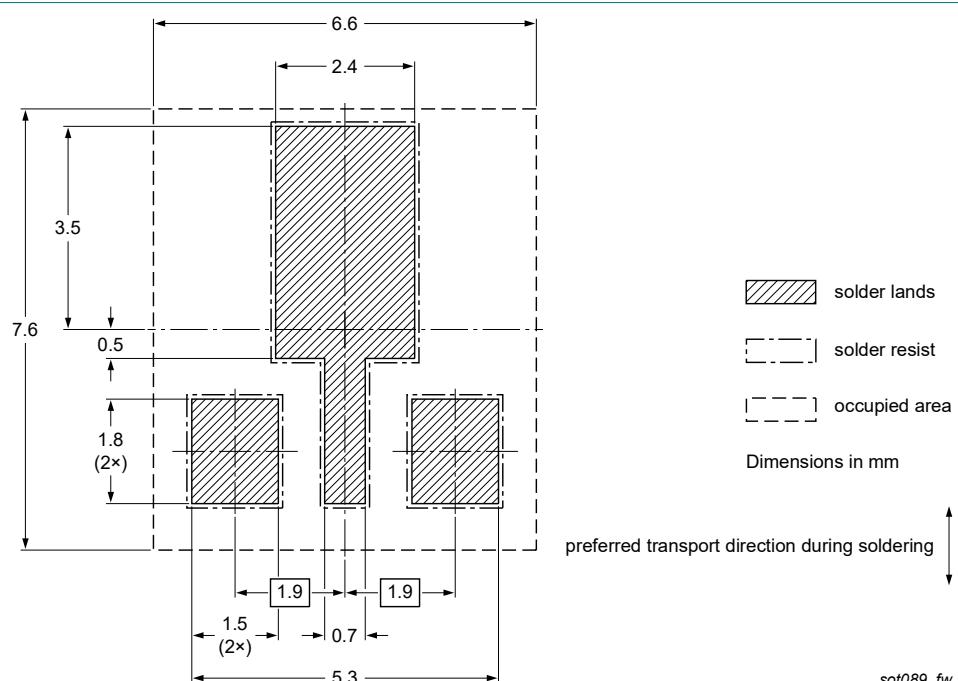


Fig. 17. Wave soldering footprint for SOT89 (SC62)

## 11. Revision history

**Table 9. Revision history**

Document ID	Release date	Data sheet status	Change notice	Supersedes
BCX56T_SER v.1	20190822	Product data sheet	-	-

## 12. Legal information

### Data sheet status

Document status [1][2]	Product status [3]	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
Preliminary [short] data sheet	Qualification	This document contains data from the preliminary specification.
Product [short] data sheet	Production	This document contains the product specification.

- [1] Please consult the most recently issued document before initiating or completing a design.
- [2] The term 'short data sheet' is explained in section "Definitions".
- [3] The product status of device(s) described in this document may have changed since this document was published and may differ in case of multiple devices. The latest product status information is available on the internet at <https://www.nexperia.com>.

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